March 1996



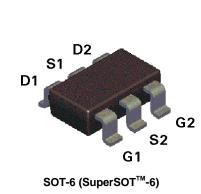
NDC7002N Dual N-Channel Enhancement Mode Field Effect Transistor

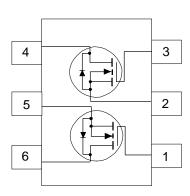
General Description

These dual N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process has been designed to minimize on-state resistance, provide rugged and reliable performance and fast switching. These devices is particularly suited for low voltage applications requiring a low current high side switch.

Features

- 0.51A, 50V, $R_{DS(ON)} = 2\Omega @ V_{GS} = 10V$
- High density cell design for low R_{DS(ON)}.
- Proprietary SuperSOT[™]-6 package design using copper lead frame for superior thermal and electrical capabilities.
- High saturation current.



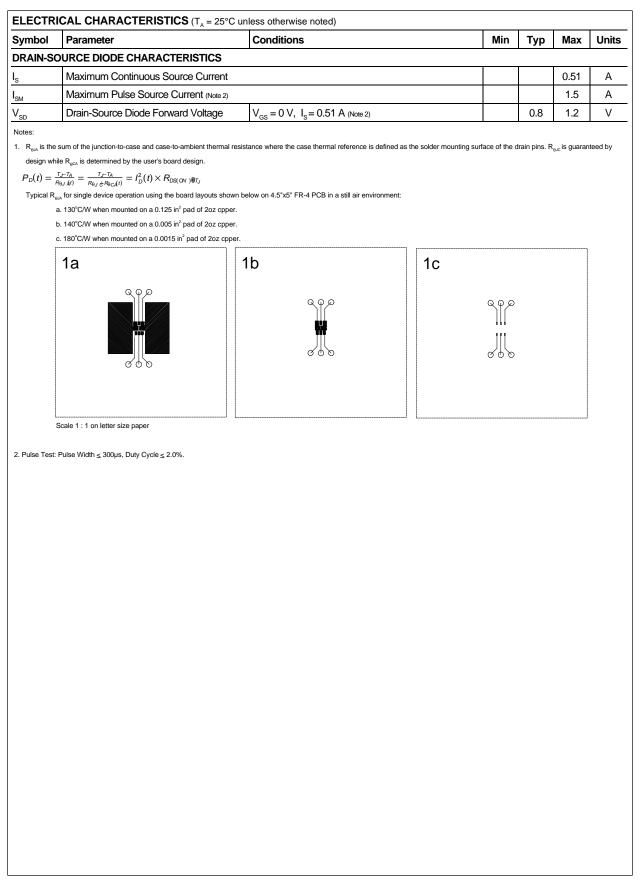


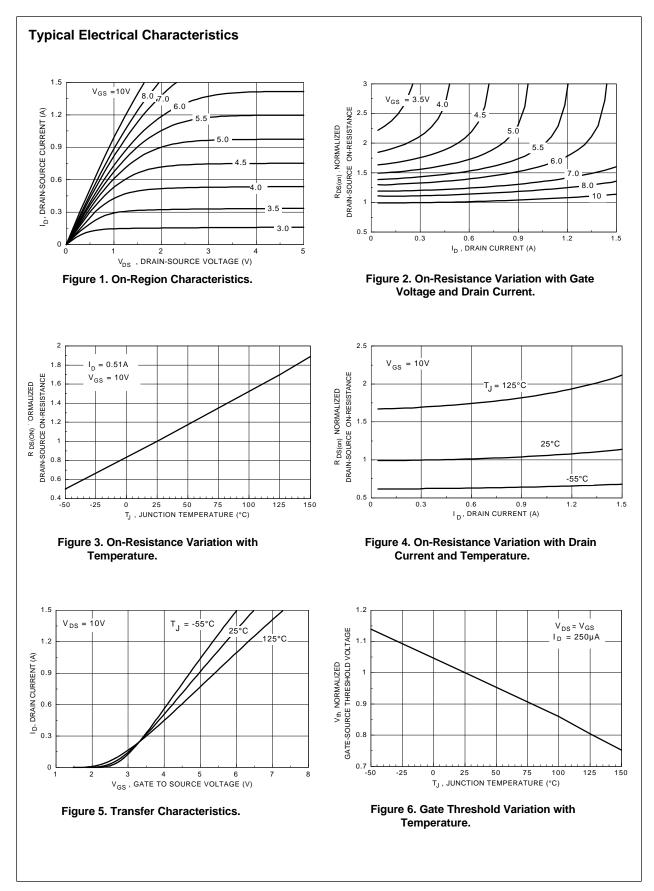
Absolute Maximum Ratings T₄ = 25°C unless otherwise noted

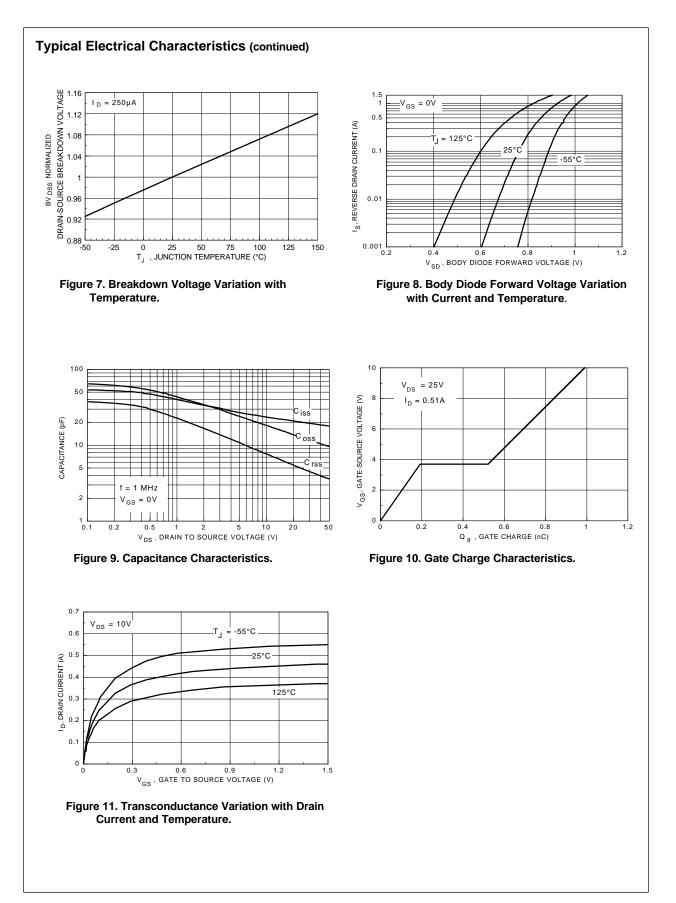
Symbol	Parameter		NDC7002N	Units
V _{DSS}	Drain-Source Voltage		50	V
V _{GSS}	Gate-Source Voltage - Continuous		20	V
I _D	Drain Current - Continuous	(Note 1a)	0.51	A
	- Pulsed		1.5	
P _D	Maximum Power Dissipation	(Note 1a)	0.96	W
		(Note 1b)	0.9	
		(Note 1c)	0.7	
T _J ,T _{STG}	Operating and Storage Temperature Range		-55 to 150	°C
THERMA	L CHARACTERISTICS			
R _{øja}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	130	°C/W
R _{øjc}	Thermal Resistance, Junction-to-Case	(Note 1)	60	°C/W

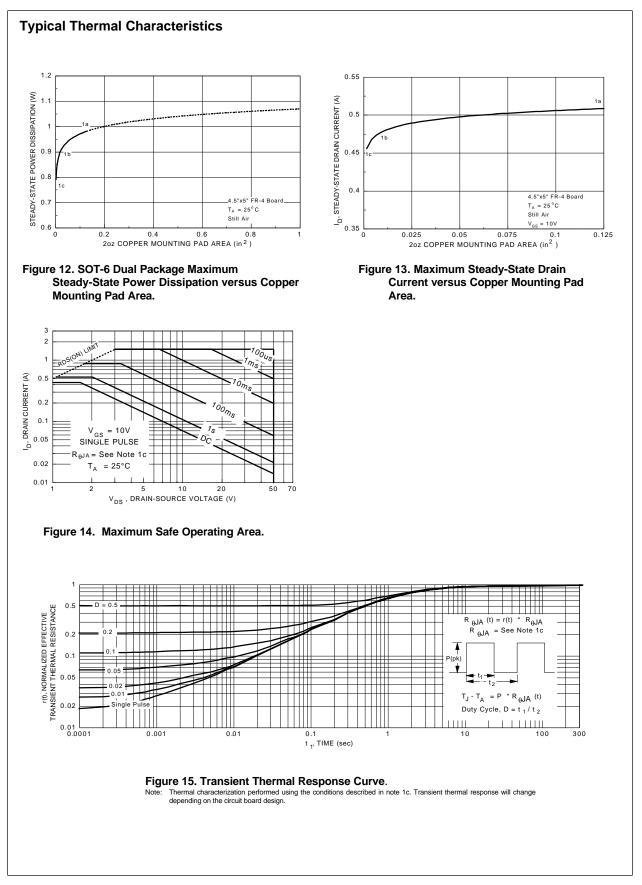
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Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	ARACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		50			V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$				1	μA
			T _J = 125°C			500	
I _{GSSF}	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
I _{GSSR}	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
ON CHAI	RACTERISTICS (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	$V_{\rm DS}=V_{\rm GS},I_{\rm D}=250\;\mu A$		1	1.9	2.5	V
			T _J = 125°C	0.8	1.5	2.2	
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, \ I_{D} = 0.51 \text{ A}$			1	2	Ω
			T _J = 125°C		1.7	3.5	
		$V_{GS} = 4.5 \text{ V}, \ I_{D} = 0.35 \text{ A}$			1.6	4	
I _{D(on)}	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 10 \text{ V}$		1.5			А
g _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 0.51 \text{ A}$			400		mS
DYNAMI	CHARACTERISTICS						T
C _{iss}	Input Capacitance	$V_{\rm DS} = 25 \rm V, \ V_{\rm GS} = 0 \rm V,$			20		pF
C _{oss}	Output Capacitance	f = 1.0 MHz			13		pF
C _{rss}	Reverse Transfer Capacitance				5		pF
SWITCHI	NG CHARACTERISTICS (Note 2)						
t _{D(on)}	Turn - On Delay Time	$V_{_{DD}} = 25 \text{ V}, \ \text{I}_{_{D}} = 0.25 \text{ A},$			6	20	nS
t,	Turn - On Rise Time	$V_{\rm GS} = ~10~\rm V, R_{\rm GEN} = 25~\Omega$			6	20	
t _{D(off)}	Turn - Off Delay Time	7			11	20	1
t _r	Turn - Off Fall Time				5	20	1
Q _g	Total Gate Charge	V _{DS} = 25 V,			1		nC
Q _{gs}	Gate-Source Charge	$I_{\rm D} = 0.51 \text{ Å}, V_{\rm GS} = 10 \text{ V}$			0.19		nC
Q _{gd}	Gate-Drain Charge				0.33		nC









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